产品规格承认书

SPECIFICATIONS

客户:	
CUSTOMER:	
产品名称:	Bluetooth ANT
DESCRIPTION:	蓝牙天线
客户型号:	
CUSTOMER PART No	
产品型号:	
OUR MODEL NO:	PBX3216MP01
日期:	
DATE:	2020/12/22

确认签字,盖章后请返回承认书一份

PLEASE RETURN TO US ONE COPY OF "SPECIFICATION FOR APPROVAL"

WITH YOUR APPROVED SIGNATURES

审核 Reviewed by 刘飞 制作 Prepa	乍 ared by
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Manufacturer

Shenzhen pengban Xingye Technology Co., Ltd

Room 1016, Mintai Building, Minzhi Avenue, Minzhi Street, Longhua New District, Shenzhen

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TITLE. CHIP2450-3216 St	necification	776		SPEC REV.
TITLE: CHIP2450-3216 Specification		NO.	3210	P1

PBX3216MP01 Specification

Operating Temp. : -40 ℃~+85 ℃

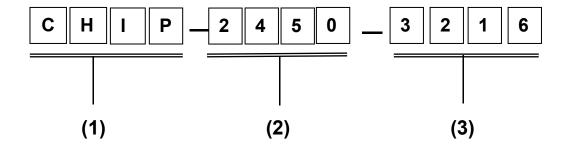
1. FEATURES:

- Light weight, compact
- Wide bandwidth, low cost
- Built-in antenna with high gain

2. APPLICATIONS:

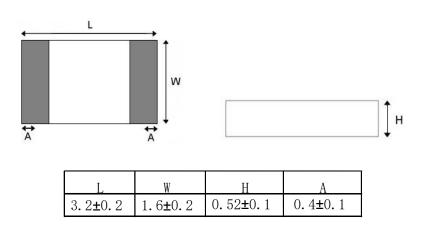
- Bluetooth, Wireless LAN, Mobile TV
- Home RF System, etc

3. PRODUCT IDENTIFICATION

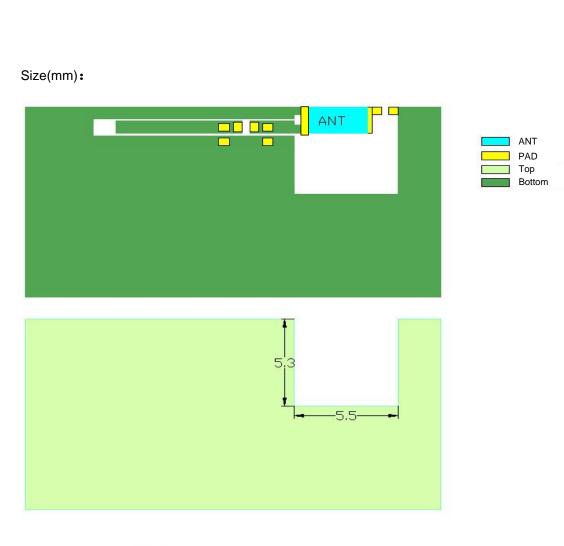


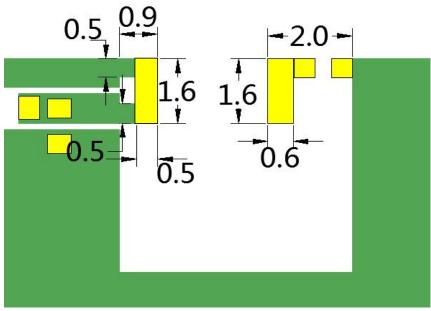
- (1) Product type: Multilayer chip Antenna
- (2) Center Frequency: 2450MHz
- (3) External Dimensions (L×W) (mm): 3.2*1.6

4. SHAPE AND DIMENSIONS:



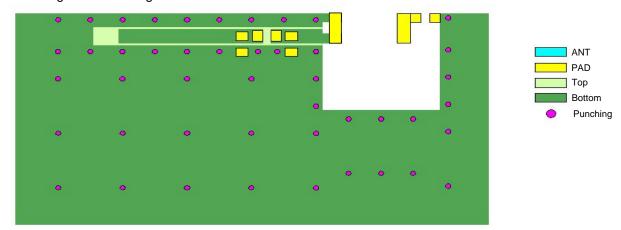
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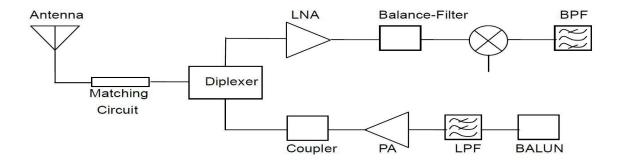


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Punching reference diagram



APPLICATION GUIDE



5. SPECIFICATIONS:

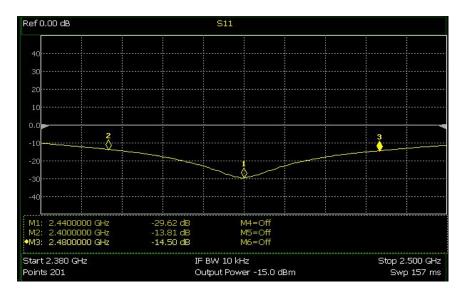
Test items	Specifications
bandwidth	2400-2483MHz
Maximum gain	2.67dbi
efficiency	72.3%
impedance	50Ω

* Test condition: Test board size 90*40 mm Matching circuit: Pi matching circuit will be required

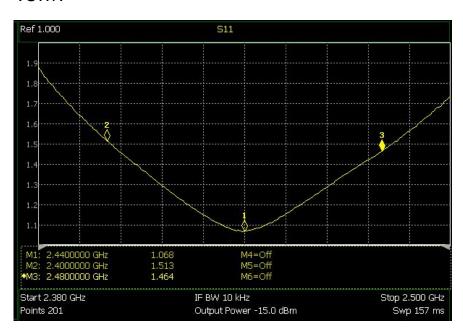
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6. Electrical Characteristics:

Loss



VSWR

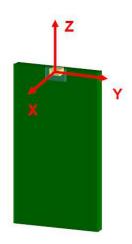


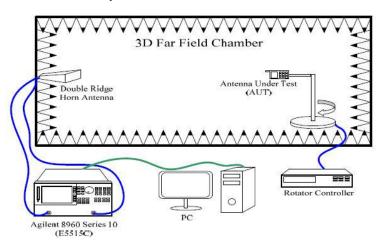
Mark	Frequency	VSWR
1	2400 MHz	1.513
2	2440 MHz	1.068
3	2480 MHz	1.464

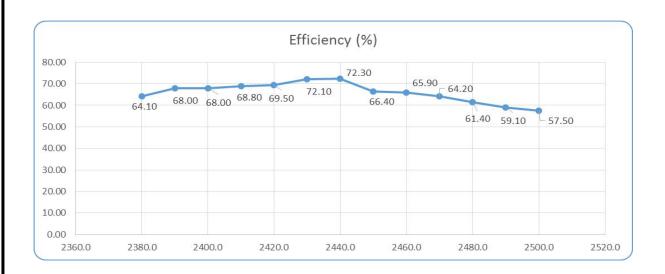
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Radiation Pattern

The Gain pattern is measured in FAR-field chamber. DUT is placed on the table of rotator,a standard horn antenna and Vector Network Analyzer is used to collect data.



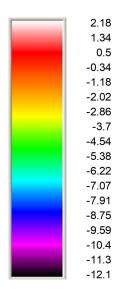


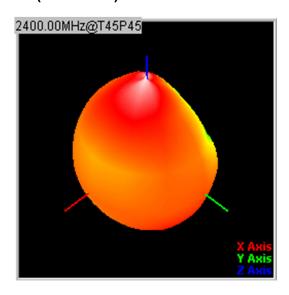




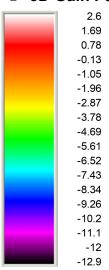
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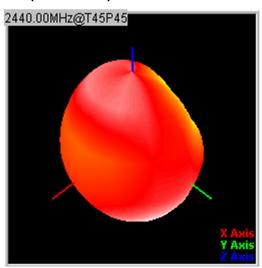
○ 3D Gain Pattern (2400 MHz)



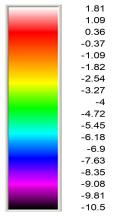


O 3D Gain Pattern (2440 MHz)

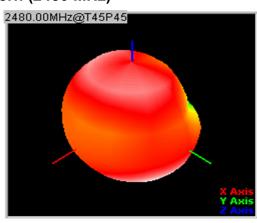




O 3D Gain Pattern (2480 MHz)



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7. Environmental Characteristics

(1) Reliability Test

Item	Condition	Specification		
Thermal shock	1. 30±3 minutes at -40° C±5° C, 2. Convert to +105° C (5 minutes) 3. 30±3 minutes at +105° C±5° C, 4. Convert to -40° C (5 minutes) 5. Total 100 continuous cycles	No apparent damage Fulfill the electrical spec. after test.		
Humidity resistance	1. Humidity: 85% R.H. 2. Temperature: $85\pm5^{\circ}$ C 3. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.		
High temperature resistance	1. Temperature: 150° C±5° C 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.		
Low temperature resistance	1. Temperature: -40° C±5° C 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.		
Soldering heat resistance	1. Solder bath temperature : $260\pm5^{\circ}$ C 2. Bathing time: 10 ± 1 seconds	No apparent damage		
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of $245\pm5^\circ\!$	No apparent damage		

(2) Storage Condition

(a) At warehouse:

The temperature should be within $0 \sim 30^{\circ}$ C and humidity should be less than 60% RH.

The product should be used within 1 year from the time of delivery.

(b) On board:

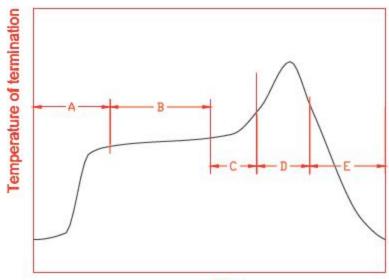
The temperature should be within -40~85°C and humidity should be less than 85% RH.

(3) Operating Temperature Range

Operating temperature range : -40 $^{\circ}$ C to +105 $^{\circ}$ C.

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8. Recommended Reflow Soldering



Time

Α	1 st rising temperature	rising temperature The normal to Preheating temperature		
В	Preheating	140°C to 160°C	60s to 120s	
С	2 nd rising temperature	Preheating to 200°C	20s to 40s	
D Main		if 220°C	50s∼60s	
		if 230°C	40s∼50s	
	Main heating	if 240°C	30s~40s	
		if 250°C	20s~40s	
		if 260°C	20s~40s	
E	Regular cooling	200°C to 100°C	1°C/s ~ 4°C/s	

^{*}reference: J-STD-020C

(1) Soldering Gun Procedure

Note the follows, in case of using solder gun for replacement.

- (a) The tip temperature must be less than 350° C for the period within 3 seconds by using soldering gun under 30 W.
- (b) The soldering gun tip shall not touch this product directly.

(2) Soldering Volume

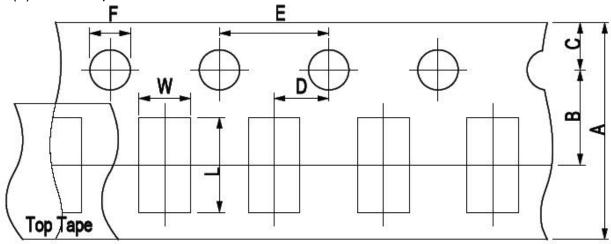
Note that excess of soldering volume will easily get crack the body of this product.

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9. Taping Package and Label Marking: (unit: mm)

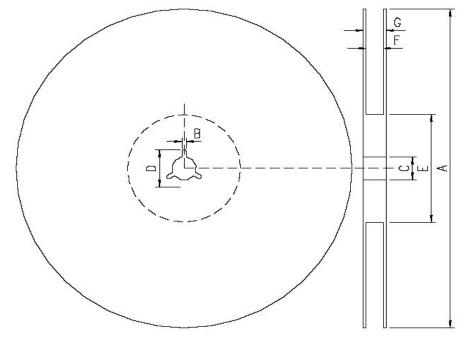
(1) Quantity/Reel: 5000pcs/Reel

(2) Carrier tape dimensions



Type	A	В	С	D	Е	F	L	W
2450-21	8.00 ± 0.3	3.50 ± 0.05	1.75 \pm 0.1	2.00 ± 0.05	4.00 ± 0.1	1.50 ± 0.1	2.30 ± 0.1	1.55 \pm 0.1

(3) Taping reel dimensions



Α	178.0±2.0
В	2.0±0.5
С	13.0±0.5
D	21.0±0.8
Ε	62.0±1.5
F	9.0±0.5
G	13.0±1.0

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